

MOSFET

OptiMOS™ 3 Power-Transistor, 150 V

Features

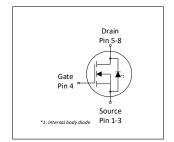
- Optimized for dc-dc conversion

- Optimized for dc-dc conversion
 N-channel, normal level
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 150 °C operating temperature
 Pb-free lead plating; RoHS compliant;
 Qualified according to JEDEC¹⁾ for target application
 Halogen-free according to IEC61249-2-21



| Table 1 Roy 1 differentianion 1 di differentia | | | | | | |
|--|-------|------|--|--|--|--|
| Parameter | Value | Unit | | | | |
| V _{DS} | 150 | V | | | | |
| R _{DS(on),max} | 52 | mΩ | | | | |
| I _D | 21 | A | | | | |











| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|------------|----------|---------------|
| BSC520N15NS3 G | PG-TDSON-8 | 520N15NS | - |

OptiMOS™ 3 Power-Transistor, 150 V BSC520N15NS3 G



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OptiMOS™ 3 Power-Transistor, 150 V **BSC520N15NS3 G**



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

| Davamatav | Cumbal | Values | | | 11 | Note / Took Condition | |
|------------------------------------|-----------------------------------|--------|------|----------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Continuous drain current | I _D | - | - | 21 14 | А | T _C =25 °C T _C =100 °C | |
| Pulsed drain current ¹⁾ | I _{D,pulse} | - | - | 84 | Α | <i>T</i> _C =25 °C | |
| Avalanche energy, single pulse | E AS | - | - | 60 | mJ | I_D =18 A, R_{GS} =25 Ω | |
| Gate source voltage | V _{GS} | -20 | - | 20 | V | - | |
| Power dissipation | P _{tot} | - | - | 57 | W | <i>T</i> _C =25 °C | |
| Operating and storage temperature | T _j , T _{stg} | -55 | - | 150 | °C | IEC climatic category; DIN IEC 68-1: 55/150/56 | |

2 Thermal characteristics

Table 3 Thermal characteristics

| Development | Cumbal | Values | | | 11:0:4 | Note / Test Condition | |
|--|-------------------|--------|------|------|--------|-----------------------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Thermal resistance, junction - case | R _{thJC} | - | - | 2.2 | K/W | - | |
| Thermal resistance, junction - ambient, 6 cm² cooling area²) | R _{thJA} | - | - | 50 | K/W | - | |

3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 Static characteristics

| Davamatav | Crossbal | Values | | | 11 | Note / Test Condition | |
|----------------------------------|-----------------------|--------|------------|----------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Drain-source breakdown voltage | $V_{(BR)DSS}$ | 150 | - | - | V | V _{GS} =0 V, I _D =1 mA | |
| Gate threshold voltage | $V_{\rm GS(th)}$ | 2 | 3 | 4 | V | $V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=35\ \mu {\rm A}$ | |
| Zero gate voltage drain current | $I_{ m DSS}$ | - | 0.01 10 | 1 100 | μA | V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C | |
| Gate-source leakage current | I _{GSS} | - | 1 | 100 | nA | V _{GS} =20 V, V _{DS} =0 V | |
| Drain-source on-state resistance | R _{DS(on)} | - | 42 42 | 52 52 | mΩ | V _{GS} =10 V, I _D =18 A V _{GS} =8 V, I _D =9 A | |
| Gate resistance | R _G | - | 2.1 | - | Ω | - | |
| Transconductance | g fs | 11 | 21 | - | S | $ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 18 A$ | |

 $^{^{1)}}$ see Diagram 3 $^{2)}$ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

OptiMOS™ 3 Power-Transistor, 150 V BSC520N15NS3 G



 Table 5
 Dynamic characteristics

| Devementer | Cumbal | Values | | | 11:4 | Note / Test Condition | |
|------------------------------|------------------|--------|------|------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Input capacitance | C _{iss} | - | 670 | 890 | pF | V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz | |
| Output capacitance | Coss | - | 80 | - | pF | V _{GS} =0 V, V _{DS} =75 V, f=1 MHz | |
| Reverse transfer capacitance | C _{rss} | - | 3.4 | - | pF | V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz | |
| Turn-on delay time | $t_{\sf d(on)}$ | _ | 7 | - | ns | $V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =9 A, $R_{\rm G}$ =1.6 Ω | |
| Rise time | t _r | _ | 4 | - | ns | $V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =9 A, $R_{\rm G}$ =1.6 Ω | |
| Turn-off delay time | $t_{ m d(off)}$ | _ | 10 | - | ns | $V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =9 A, $R_{\rm G}$ =1.6 Ω | |
| Fall time | t _f | - | 3 | - | ns | $V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =9 A, $R_{\rm G}$ =1.6 Ω | |

Table 6 Gate charge characteristics¹⁾

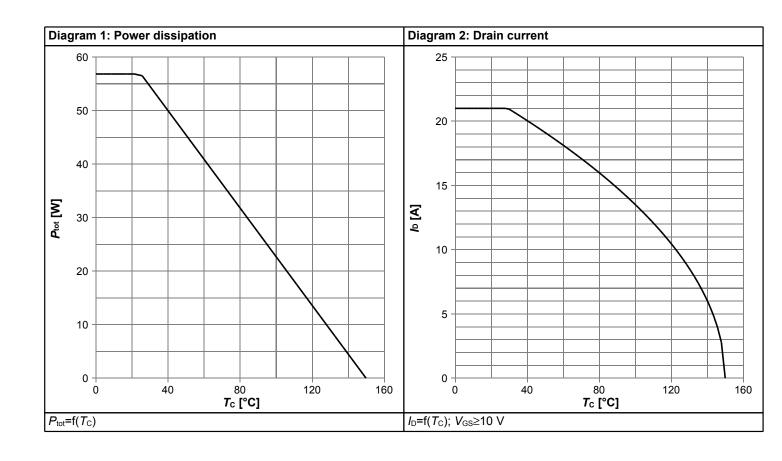
| Dougnatou | Cymahal | | Values | | | Nata / Tank Oam dition | |
|-----------------------|----------------------|---|--------|------|------|---|--|
| Parameter | Symbol | | Тур. | Max. | Unit | Note / Test Condition | |
| Gate to source charge | Q _{gs} | - | 3.5 | 4.6 | nC | $V_{\rm DD}$ =75 V, $I_{\rm D}$ =9 A, $V_{\rm GS}$ =0 to 10 V | |
| Gate to drain charge | Q _{gd} | - | 1.5 | - | nC | $V_{\rm DD}$ =75 V, $I_{\rm D}$ =9 A, $V_{\rm GS}$ =0 to 10 V | |
| Switching charge | Q _{sw} | - | 3 | - | nC | $V_{\rm DD}$ =75 V, $I_{\rm D}$ =9 A, $V_{\rm GS}$ =0 to 10 V | |
| Gate charge total | Qg | - | 8.7 | 12 | nC | $V_{\rm DD}$ =75 V, $I_{\rm D}$ =9 A, $V_{\rm GS}$ =0 to 10 V | |
| Gate plateau voltage | V _{plateau} | - | 5.2 | - | V | $V_{\rm DD}$ =75 V, $I_{\rm D}$ =9 A, $V_{\rm GS}$ =0 to 10 V | |
| Output charge | Qoss | - | 22 | 29 | nC | V _{DD} =75 V, V _{GS} =0 V | |

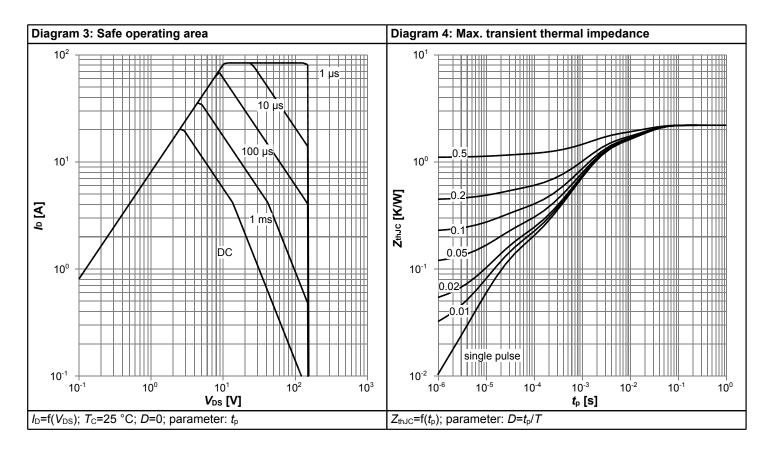
Table 7 Reverse diode

| Parameter | Cymhol | Values | | | Unit | Note / Test Condition | |
|---------------------------------|------------------------|--------|------|------|-------|--|--|
| Parameter | Symbol | Min. | Тур. | Max. | Ullit | Note / Test Condition | |
| Diode continous forward current | Is | - | - | 21 | Α | T _C =25 °C | |
| Diode pulse current | I _{S,pulse} | - | - | 84 | Α | <i>T</i> _C =25 °C | |
| Diode forward voltage | V _{SD} | - | 0.9 | 1.2 | V | V _{GS} =0 V, I _F =21 A, T _j =25 °C | |
| Reverse recovery time | <i>t</i> _{rr} | - | 66 | - | ns | V _R =50 V, I _F =9 A, d <i>i</i> _F /d <i>t</i> =100 A/μs | |
| Reverse recovery charge | Qrr | - | 226 | - | nC | V_R =50 V, I_F =9 A, d i_F /d t =100 A/ μ s | |

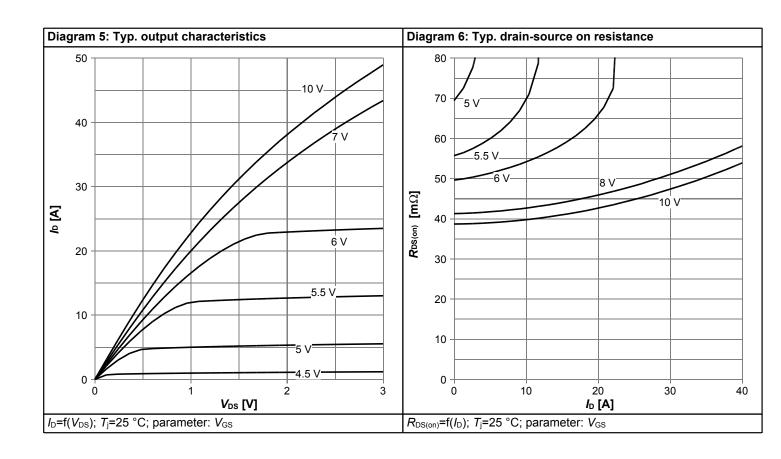


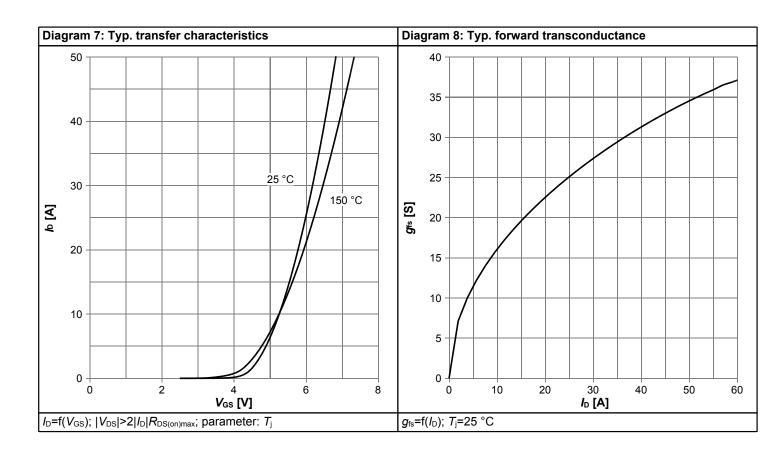
4 Electrical characteristics diagrams



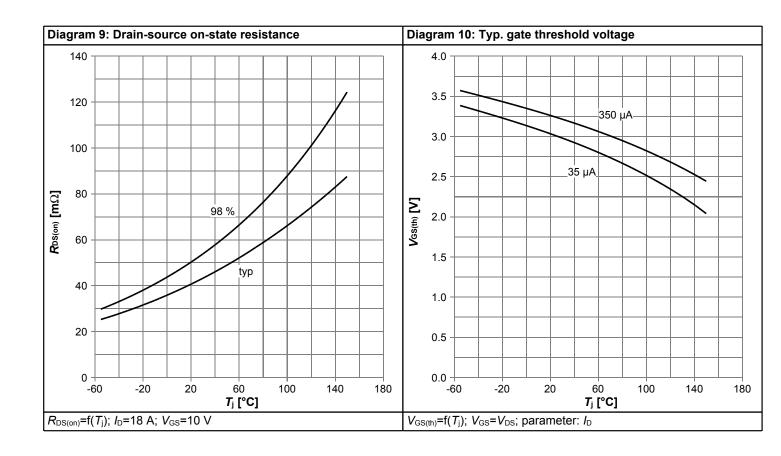


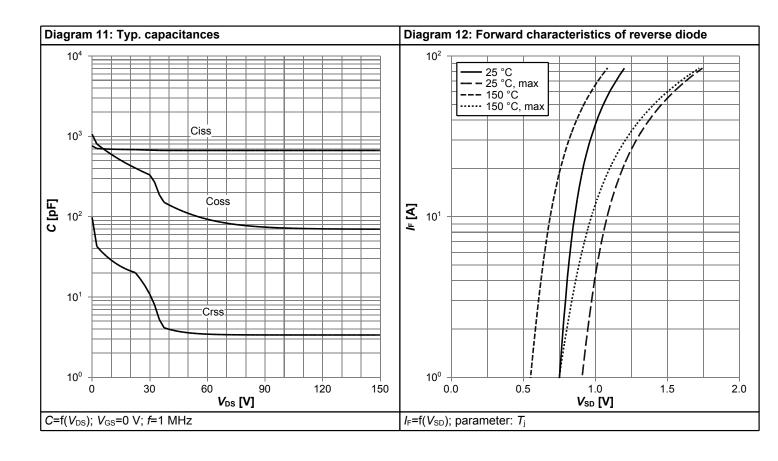




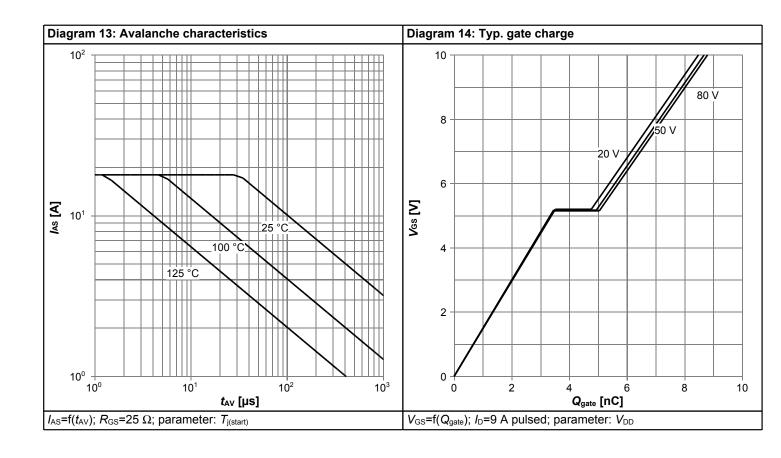


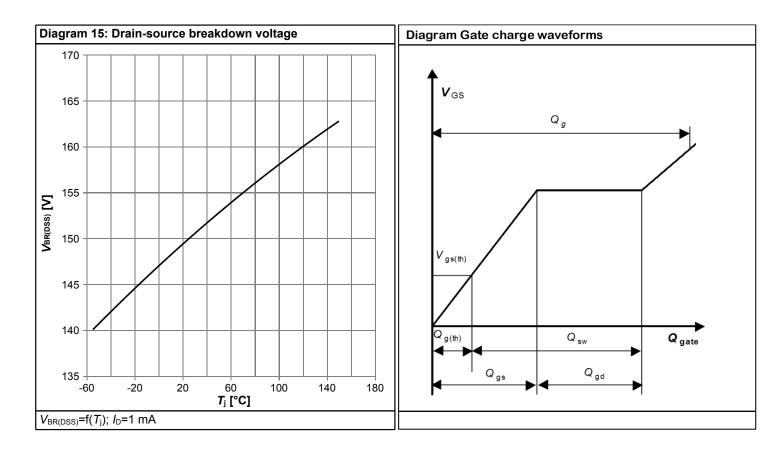






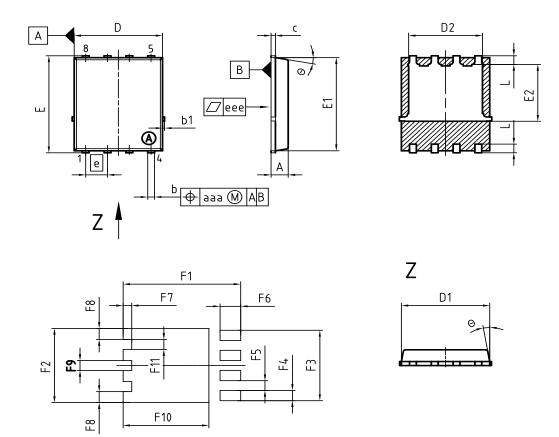








5 Package Outlines



| DIM | MILLIN | IETERS | INC | HES | | |
|------|--------|--------|-------|-------|--|--|
| DIM | MIN | MAX | MIN | MAX | | |
| Α | 0.90 | 1.10 | 0.035 | 0.043 | | |
| b | 0.34 | 0.54 | 0.013 | 0.021 | | |
| b1 | 0.02 | 0.22 | 0.001 | 0.008 | | |
| С | 0.15 | 0.35 | 0.006 | 0.014 | | |
| D=D1 | 4.95 | 5.35 | 0.195 | 0.211 | | |
| D2 | 4.20 | 4.40 | 0.165 | 0.173 | | |
| E | 5.95 | 6.35 | 0.234 | 0.250 | | |
| E1 | 5.70 | 6.10 | 0.224 | 0.240 | | |
| E2 | 3.40 | 3.80 | 0.134 | 0.150 | | |
| e | 1.2 | 27 | 0.050 | | | |
| N | | 8 | 8 | | | |
| L | 0.45 | 0.65 | 0.018 | 0.026 | | |
| Θ | 8.5° | 11.5° | 8.5° | 11.5° | | |
| aaa | 0.2 | 25 | 0.0 | 010 | | |
| eee | 0.0 | 05 | 0.002 | | | |
| F1 | 6.75 | 6.95 | 0.266 | 0.274 | | |
| F2 | 4.60 | 4.80 | 0.181 | 0.189 | | |
| F3 | 4.36 | 4.56 | 0.172 | 0.180 | | |
| F4 | 0.55 | 0.75 | 0.022 | 0.030 | | |
| F5 | 0.52 | 0.72 | 0.020 | 0.028 | | |
| F6 | 1.10 | 1.30 | 0.043 | 0.051 | | |
| F7 | 0.40 | 0.60 | 0.016 | 0.024 | | |
| F8 | 0.60 | 0.80 | 0.024 | 0.031 | | |
| F9 | 0.53 | 0.73 | 0.021 | 0.029 | | |
| F10 | 4.90 | 5.10 | 0.193 | 0.201 | | |
| F11 | 0.53 | 0.73 | 0.021 | 0.029 | | |

| DOCUMEI Z8B0000 | |
|--------------------|------------|
| SCALE | 0 |
| 0 2.5 LL | 2.5 5mm |
| EUROPEAN PI | ROJECTION |
| | |
| ISSUE D 08-03-2 | |
| REVIS 03 | ION |

Figure 1 Outline PG-TDSON-8, dimensions in mm/inches



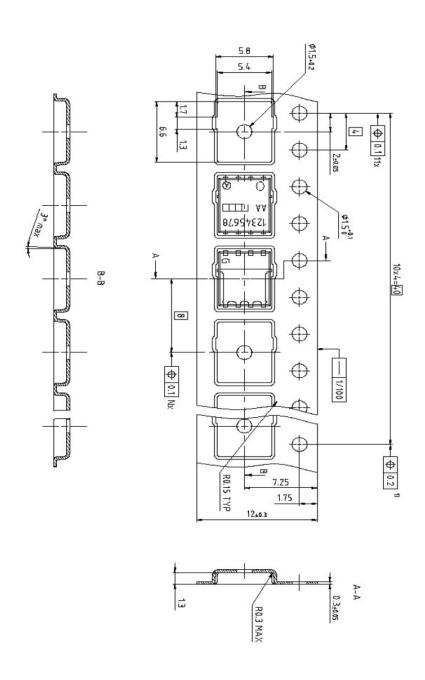


Figure 2 Outline Tape (PG-TDSON-8), dimensions in mm

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Revision History

BSC520N15NS3 G

Revision: 2023-03-24, Rev. 2.3

Previous Revision

| Revision | Date | Subjects (major changes since last revision) | | | |
|----------|------------|--|--|--|--|
| 2.3 | 2023-03-24 | Fix bug Diagram 4 | | | |

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Final Data Sheet 11 Rev. 2.3, 2023-03-24